

What is claimed is:

1 1. A micro-actuator comprising
2 a base plate on which a predetermined pattern of signal lines is formed;
3 a plurality of fixed comb-type electrodes that are arranged on the base plate
4 and extend in a direction perpendicular to the base plate;
5 a stage capable of a see-saw motion that is arranged at a predetermined
6 height from the top of the base plate;
7 a plurality of driving comb-type electrodes which are formed parallel to each
8 other on the bottom of the stage and whose ends extend between the fixed comb-
9 type electrodes;
10 a torsion bar with a predetermined length that is arranged at both ends of the
11 stage forming one body with the stage in order to enable the see-saw motion of the
12 stage;
13 a first frame layer connected to both ends of the torsion bar;
14 a second frame layer that is positioned below the first frame layer, thus
15 forming a layered structure with the first frame layer; and
16 a metal eutectic bonding layer formed between the first and second frame
17 layers to bond them together.

1 2. The micro-actuator of claim 1, wherein the first frame layer, the torsion
2 bar, the stage, and the driving comb-type electrodes form one body.

1 3. The micro-actuator of claim 1, wherein
2 the first frame layer has a shape of a rectangular border that surrounds the
3 stage;
4 a separate region of a predetermined width is prepared between the first
5 frame layer and the stage; and
6 the torsion bar crosses the separate region.

1 4. The micro-actuator of claim 1, wherein
2 the first frame layer has a shape of a rectangular border that surrounds the
3 stage;
4 a separate region of a predetermined width having a shape of rectangular
5 border is prepared between the first frame layer and the stage; and
6 the torsion bar crosses the separate region.

1 5. The micro-actuator of any of claims 1 - 4, wherein
2 the fixed comb-type electrodes are formed on an electrode base that is
3 arranged on the base plate, and
4 the electrode base, the fixed comb-type electrodes and the second frame
5 layer are formed of the same material plate.

1 6. The micro-actuator of claim 5, wherein the height of the fixed comb-
2 type electrodes is greater than that of the second frame layer, and thus the front
3 ends of the fixed comb-type electrodes are positioned higher than the top of the
4 second frame layer.

1 7. The micro-actuator of any of claims 1 - 4, wherein the height of the
2 fixed comb-type electrodes is greater than that of the second frame layer, and thus
3 the front ends of the fixed comb-type electrodes are positioned higher than the top
4 of the second frame layer.

1 8. The micro-actuator of any of claims 1 - 4, and 6, wherein
2 the front ends of the driving comb-type electrodes and the first frame layer are on a
3 common plane.

1 9. The micro-actuator of claim 5, wherein the front ends of the driving
2 comb-type electrodes and the first frame layer are on a common plane.

1 10. The micro-actuator of any of claims 1 - 4, 6, and 9, wherein the metal
2 eutectic bonding layer of the present invention is composed of a plurality of metal
3 layers, among which the middle metal layer is plated with Au/Sn alloy.

1 11. A method for manufacturing a micro-actuator comprising the steps of:
2 forming a top structure by etching both sides of a first plate, the top structure
3 comprising a stage, a plurality of comb-type electrodes formed on the bottom of the
4 stage, a torsion bar positioned in the middle of both edges facing the stage, and a
5 first frame layer of a predetermined height supporting the torsion bar;

6 forming a bottom structure by etching both sides of a second plate, the
7 bottom structure comprising a base plate, a second frame layer formed on the base
8 plate and having a predetermined height corresponding to the first frame layer
9 height, and a plurality of fixed comb-type electrodes formed on the base plate; and

10 joining the top and bottom structure to form one body by forming a eutectic
11 bonding layer between the first frame layer and the second frame layer, and
12 superimposing the driving and fixed comb-type electrodes such that the extensions
13 of the driving comb-type electrodes alternate with the extensions of the fixed comb-
14 type electrodes

1 12. The method for manufacturing a micro-actuator of claim 11, wherein
2 the step of forming the top structure further comprises the steps of:

3 forming a top separate region with a predetermined width and depth
4 corresponding to the space between the stage and the first frame layer;

5 forming a top metal layer on a region corresponding to the first frame layer;
6 and

7 forming the driving comb-type electrodes with a predetermined height on the
8 bottom of the stage, while the separate region is penetrated by etching the bottom of
9 the first plate with a predetermined pattern.

1 13. The method for manufacturing a micro-actuator of claim 11, wherein
2 the step of forming the bottom structure further comprise the steps of:

3 forming signal lines with a predetermined pattern corresponding to the
4 constituent elements;

5 forming a bottom separate region with a predetermined width and depth
6 corresponding to the space between the second frame layer and the fixed comb-
7 type electrodes;

8 joining the bottom of the second plate to the top of the base plate;

9 etching the region corresponding to the second frame layer to a
10 predetermined depth on the top of the second plate;

11 forming a bottom metal layer on the etched part of the second plate;

12 forming a mask layer on the region corresponding to the second frame layer
13 and the fixed comb-type electrodes on top of the second plate; and

14 forming the fixed comb-type electrodes with a predetermined height inside of
15 the bottom separate region, while the bottom separate region is penetrated by
16 etching to a predetermined depth the region that is not covered by the mask layer.

1 14. The method for manufacturing the micro-actuator of claim 12, wherein
2 the step of forming the bottom structure further comprise the steps of:

3 forming signal lines with a predetermined pattern corresponding to the
4 constituent elements;

5 forming a bottom separate region with a predetermined width and depth
6 corresponding to the space between the second frame layer and the fixed comb-
7 type electrodes;

8 joining the bottom of the second plate to the top of the base plate;

9 etching the region corresponding to the second frame layer to a
10 predetermined depth on the top of the second plate;
11 forming a bottom metal layer on the etched part of the second plate;
12 forming a mask layer on the region corresponding to the second frame layer
13 and the fixed comb-type electrode on top of the second plate; and
14 forming the fixed comb-type electrode with a predetermined height inside of
15 the bottom separate region, while the bottom separate region is penetrated by
16 etching to a predetermined depth the region that is not covered by the mask layer.

1 15. The method for manufacturing a micro-actuator of claims 12 or 14,
2 wherein the step of forming the top metal layer further comprises the steps of
3 forming a metal seed layer on the bottom of the first plate; and
4 forming a metal eutectic bonding layer by a plating method on the seed layer.

1 16. The method for manufacturing a micro-actuator of claim 15, wherein
2 the step of joining the top and bottom structures into one body further comprises a
3 step of performing the metal eutectic bonding at a predetermined temperature and
4 pressure in order to join the first frame layer of the top structure to the second frame
5 layer of the bottom structure, and more specifically to join the top metal layer of the
6 first frame layer of the top structure to the bottom metal layer of the second frame
7 layer of the bottom structure.

1 17. The method for manufacturing a micro-actuator of claims 13 or 14,
2 wherein the step of forming a bottom metal layer on the second frame layer of the
3 bottom structure further comprises a step of performing the metal eutectic bonding
4 at a predetermined temperature and pressure in order to join the first frame layer of
5 the top structure to the second frame layer of the bottom structure, and more
6 specifically to join the top metal layer of the first frame layer of the top structure to
7 the bottom metal layer of the second frame layer of the bottom structure.

1 18. The method for manufacturing a micro-actuator of any of claims 11-16,
2 wherein the bottom of the second plate is joined to the top of the base plate by an
3 anodic bonding process.

1 19. The method for manufacturing the micro-actuator of any of claims 17,
2 wherein the bottom of the second plate is joined to the top of the base plate by an
3 anodic bonding process.